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(12) **United States Design Patent** (10) **Patent No.:** **US D949,117 S**
McBride et al. (45) **Date of Patent:** **** Apr. 19, 2022**

- (54) **CIRCUIT BOARD**
- (71) Applicant: **THE NOCO COMPANY**, Glenwillow, OH (US)
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- (**) Term: **15 Years**
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Related U.S. Application Data

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- (51) **LOC (13) Cl.** **13-03**
- (52) **U.S. Cl.**
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- (58) **Field of Classification Search**
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CPC H05K 3/30; H05K 3/301; H05K 3/284; H05K 3/303; H05K 1/18; H05K 1/181; H05K 1/182; H05K 1/183; H05K 1/185; H05K 1/00; H05K 7/1417; H05K 7/02; H05K 7/12; H05K 7/06; H01L 2924/14
See application file for complete search history.

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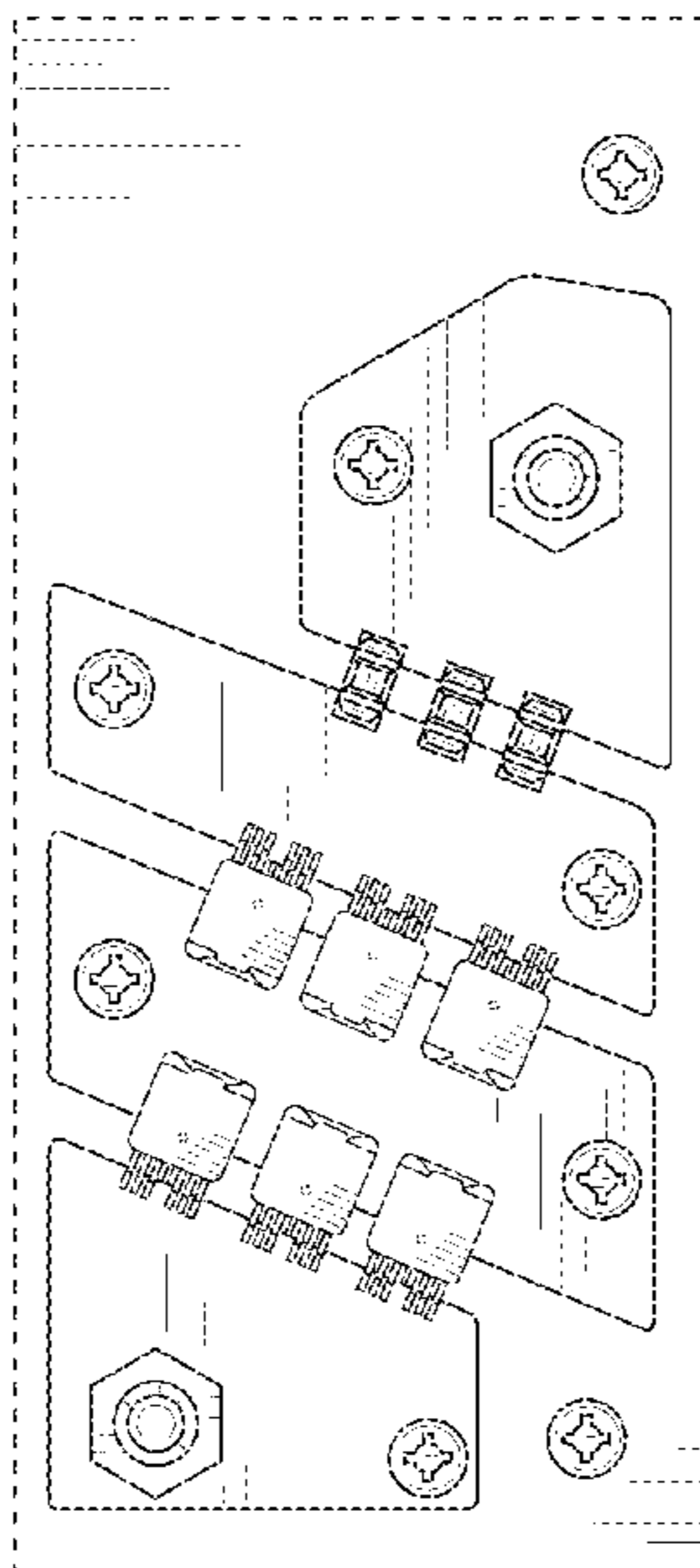
(57) **CLAIM**

The ornamental design for a circuit board, as shown and described.

DESCRIPTION

The sole FIGURE is a front elevational view of a circuit board, showing our new design. The broken lines shown in the drawings depict environmental structure or portions of the article that form no part of the claimed design.

1 Claim, 1 Drawing Sheet



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